

# NL3S22S

## USB 2.0 + Audio Switch

The NL3S22S is a double-pole/double-throw (DPDT) analog switch for routing high speed differential data and audio. The high-speed data path is compliant with High Speed USB 2.0, Full Speed USB 1.1, Low Speed USB 1.0 and any generic UART protocol. The multi-purpose audio path is capable of passing signals with negative voltages as low as 2 V below ground and features shunt resistors to reduce Pop and Click noise in the audio system.

### Features

- $V_{CC}$  Range: 2.7 V to 5.5 V
- Control Pins Compatible with 1.8 V Interfaces
- $I_{CC}$ : 23  $\mu$ A (Typ)
- ESD Performance: 4 kV HBM
- Available in 1.4 mm x 1.8 mm UQFN10
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

### High Speed Data Path

- Input Signal Range: 0 V to 3.7 V
- $R_{DS(on)}$ : 5  $\Omega$  (Typ)
- $C_{ON}$ : 4.5 pF (Typ)
- Data Rate: USB 2.0-Compliant – up to 480 Mbps

### Audio Path

- Input Signal Range: -2.0 V to 2.0 V
- $R_{DS(on)}$ : 3  $\Omega$  (Typ)
- $R_{ON(FLAT)}$ : 0.002  $\Omega$  (Typ)
- THD: 0.002% ( $R_L = 16 \Omega$  /  $V_{IS} = 0.4 V_{RMS}$ )

### Applications

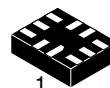
- Smartphones
- Tablets
- USB 2.0 Hosts/Peripherals
- Audio / High-Speeds Data Switching



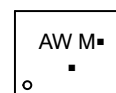
**ON Semiconductor®**

[www.onsemi.com](http://www.onsemi.com)

### MARKING DIAGRAM



UQFN10  
CASE 488AT



AW = Device Code  
M = Date Code  
▪ = Pb-Free Device

(Note: Microdot may be in either location)

### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
NL3S22SMUTAG	UQFN10 (Pb-Free)	3000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

NL3S22S

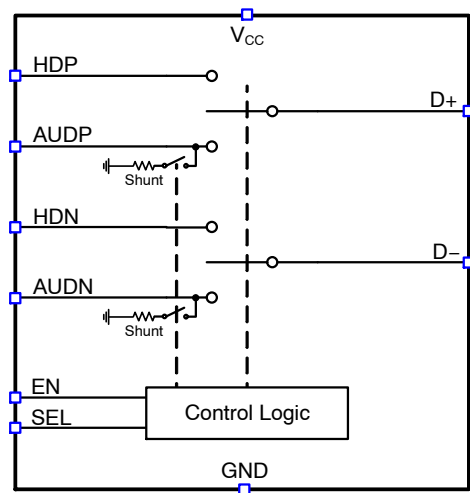


Figure 1. Block Diagram

FUNCTION TABLE

EN	SEL	Shunt Status	D+/D- Function
0	X	ON	No Connect
1	0	OFF	AUDP/AUDN
1	1	ON	HDP/HDN

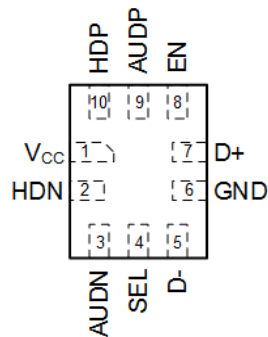


Figure 2. UQFN10 – Top Through View

PIN DESCRIPTION

Pin Name	Pin	Description
V <sub>CC</sub>	1	Power Supply
HDN	2	High Speed Differential Data (-)
AUDN	3	Audio Signal (-)
SEL	4	Function Select
D-	5	Audio/Data Common I/O (-)
GND	6	Ground
D+	7	Audio/Data Common I/O (+)
EN	8	Chip Enable
AUDP	9	Audio Signal (+)
HDP	10	High Speed Differential Data (+)

# MAXIMUM RATINGS

Rating	Symbol	Value	Unit
V <sub>CC</sub>	Positive DC Supply Voltage	−0.3 to +6	V
V <sub>IS</sub>	Analog Input/Output Voltage HDP, HDN	−0.3 to +5.5	V
	AUDP, AUDN	−2.5 to V <sub>CC</sub> + 0.3	
	D+, D−	−2.5 to +5.5	
V <sub>IN</sub>	Digital Control Pin Voltage on EN, SEL	−0.3 to V <sub>CC</sub> + 0.3	V
T <sub>s</sub>	Storage Temperature	−55 to +150	°C
T <sub>L</sub>	Lead Temperature, 1 mm from Case for 10 seconds	260	°C
T <sub>J</sub>	Junction Temperature Under Bias	150	°C
MSL	Moisture Sensitivity (Note 1)	Level 1	
I <sub>LU</sub>	Latchup Current (Note 2)	±100	mA
ESD	ESD Protection (Note 3) Human Body Model	4000	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Moisture Sensitivity Level (MSL): 1 per IPC/JEDEC standard: J-STD-020A.
2. Latch up Current Maximum Rating: ±100 mA per JEDEC standard: JESD78.
3. This device series contains ESD protection and passes the following tests:  
Human Body Model (HBM) ±4.0 kV per JEDEC standard: JESD22-A114 for all pins.

# RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V <sub>CCEN</sub>	Positive DC Supply Voltage	2.7	5.5	V
V <sub>IS</sub>	Switch Input / Output Voltage (Note 4) HDP, HDN	0	3.7	V
	AUDP, AUDN	−2.0	2.0	
	D+, D−	−2.0	3.7	
V <sub>IN</sub>	Digital Control Input Voltage	GND	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature Range	−40	+85	°C

4. If the audio channel is not in use, it is recommended that no signals are applied on the audio inputs AUDN and AUDP.

# NL3S22S

## DC ELECTRICAL CHARACTERISTICS (Typical values are at $V_{CC} = +3.6\text{ V}$ and $T_A = +25\text{ }^{\circ}\text{C}$ )

Symbol	Parameter	Test Conditions	$V_{CC}$ (V)	-40 °C to 85 °C			Unit
				Min	Typ	Max	

### POWER SUPPLY

$I_{CC}$	Supply Current	$I_{IS} = 0\text{ mA}$	4.2	–	23	105	$\mu\text{A}$
----------	----------------	------------------------	-----	---	----	-----	---------------

### Control Logic (EN, SEL)

$V_{IH}$	Input High Voltage		4.2	1.5	–	–	V
			3.6	1.4	–	–	
			2.7	1.3	–	–	
$V_{IL}$	Input Low Voltage		4.2	–	–	0.4	V
			3.6	–	–	0.4	
			2.7	–	–	0.4	
$V_{IHYS}$	Input Hysteresis		2.7 – 5.5	–	250	–	mV
$I_{IN}$	Leakage Current		2.7 – 5.5	–	–	$\pm 150$	nA

### AUDIO SWITCH (AUDP/AUDN $\leftrightarrow$ D+/D–)

$R_{ON}$	ON–Resistance	$V_{IS} = -2.0\text{ V to } 2.0\text{ V}, I_{IS} = 50\text{ mA}$	3.0	–	3	5	$\Omega$
$\Delta R_{ON}$	ON–Resistance Matching Between Channels	$V_{IS} = -2.0\text{ V to } 2.0\text{ V}, I_{IS} = 50\text{ mA}$	3.0	–	0.05	–	$\Omega$
$R_{FLAT(ON)}$	ON Resistance Flatness	$V_{IS} = -2.0\text{ V to } 2.0\text{ V}, I_{IS} = 50\text{ mA}$	3.0	–	0.002	–	$\Omega$
$R_{SH}$	Shunt Resistance		3.6	–	125	200	$\Omega$

### DATA SWITCH (HDP/HDN $\leftrightarrow$ D+/D–)

$R_{ON}$	ON–Resistance	$V_{IS} = 0\text{ V to } 1.7\text{ V}, I_{IS} = 15\text{ mA}$	3.0	–	5	7.5	$\Omega$
$\Delta R_{ON}$	ON–Resistance Matching Between Channels	$V_{IS} = 0\text{ V to } 1.7\text{ V}, I_{IS} = 15\text{ mA}$	3.0	–	0.02	–	$\Omega$
$R_{FLAT(ON)}$	ON Resistance Flatness	$V_{IS} = 0\text{ V to } 1.7\text{ V}, I_{IS} = 15\text{ mA}$	3.0	–	0.003	–	$\Omega$
$I_{SW(OFF)}$	OFF–State Leakage	$V_{IS} = 0\text{ V to } 3.6$	3.6	–	–	200	nA
$I_{SW(ON)}$	ON–State Leakage	$V_{IS} = 0\text{ V to } 3.6$	3.6	–	–	$\pm 200$	nA

# NL3S22S

## AC ELECTRICAL CHARACTERISTICS (Typical values are at $V_{CC} = +3.6\text{ V}$ and $T_A = +25\text{ }^{\circ}\text{C}$ )

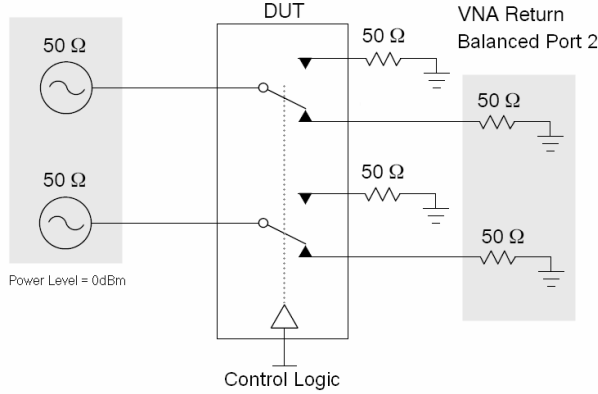
Symbol	Parameter	Test Conditions	V <sub>CC</sub> (V)	–40 °C to 85 °C			Unit
				Min	Typ	Max	
AUDIO SWITCH (AUDP/AUDN ↔ D+/D–)							
THD	Audio THD	f = 20 Hz to 20 kHz, V <sub>IS</sub> = 0.4 V <sub>RMS</sub> , DC Bias = 0 V, R <sub>L</sub> = 16 Ω	2.7 – 5.5	–	0.002	–	%
PSRR	Power Supply Ripple Rejection	From V <sub>CC</sub> unto AUDP/AUDN, f = 217 Hz, R <sub>L</sub> = 16 Ω	2.7 – 5.5	–	118	–	dB
DATA SWITCH (HDP/HDN ↔ D+/D–)							
C <sub>ON</sub>	Equivalent ON–Capacitance	Switch ON, f = 1 MHz	3.6	–	4.84	–	pF
C <sub>OFF</sub>	Equivalent OFF–Capacitance	Switch OFF, f = 1 MHz	3.6	–	2.06	–	pF
D <sub>IL</sub>	Differential Insertion Loss	f = 10 MHz	2.7 – 5.5	–	–0.42	–	dB
		f = 800 MHz	2.7 – 5.5	–	–1.89	–	
		f = 1.1 GHz	2.7 – 5.5	–	–3.01	–	
D <sub>ISO</sub>	Differential Off–Isolation	f = 10 MHz	2.7 – 5.5	–	–60	–	dB
		f = 800 MHz	2.7 – 5.5	–	–15	–	
		f = 1.1 GHz	2.7 – 5.5	–	–15	–	
D <sub>CTK</sub>	Differential Crosstalk	f = 10 MHz	2.7 – 5.5	–	–67	–	dB
		f = 800 MHz	2.7 – 5.5	–	–23	–	
		f = 1.1 GHz	2.7 – 5.5	–	–19	–	
PSRR	Power Supply Ripple Rejection	From V <sub>CC</sub> unto D+/D–, f = 217 Hz, R <sub>L</sub> = 50 Ω	2.7 – 5.5	–	108	–	dB
DYNAMIC TIMING							
t <sub>PD</sub>	Propagation Delay (Notes 5 and 6)	V <sub>NO<sub>n</sub></sub> or V <sub>NC<sub>n</sub></sub> = 0V, R <sub>L</sub> = 50 Ω,	2.7 – 5.5	–	0.25	–	ns
t <sub>ON</sub>	Turn–On Time	V <sub>IS</sub> = 1 V, R <sub>L</sub> = 50 Ω, C <sub>L</sub> = 7 pF (fix- ture only)	2.7 – 5.5				μs
		EN or SEL to AUDP/AUDN		–	2.2	–	
		EN or SEL to HDP/HDN		–	6.2	–	
t <sub>OFF</sub>	Turn–Off Time	V <sub>IS</sub> = 1 V, R <sub>L</sub> = 50 Ω, C <sub>L</sub> = 7 pF (fix- ture only)	2.7 – 5.5				ns
		EN or SEL to AUDP/AUDN		–	67	–	
		EN or SEL to HDP/HDN		–	1200	–	
t <sub>sk(b–b)</sub>	Bit to bit skew	Within the same differential channel	2.7 – 5.5	–	5	–	ps
t <sub>sk(ch–ch)</sub>	Channel to channel skew	Maximum skew between all chan- nels	2.7 – 5.5	–	5	–	ps

5. Guaranteed by design.

6. No other delays than the RC network formed by the load resistance and the load capacitance of the switch are added on the bus. For a 10 pF load, this delay is 5 ns which is much smaller than rise and fall time of typical driving systems. Propagation delays on the bus are determined by the driving circuit on the driving side and its interactions with the load of the driven side.

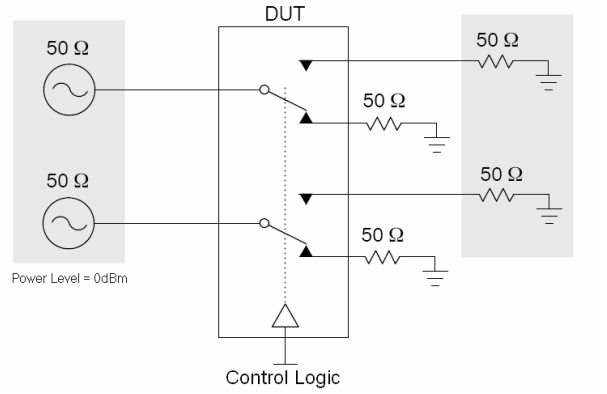
# PARAMETER MEASUREMENT INFORMATION

VNA Source  
Balanced Port 1

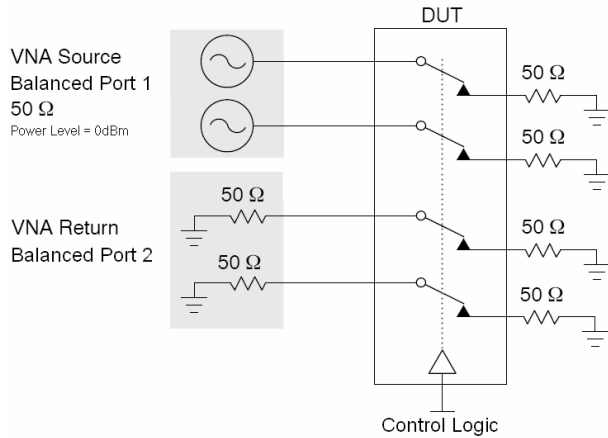


**Figure 3. Differential Insertion Loss ( $S_{DD21}$ )**

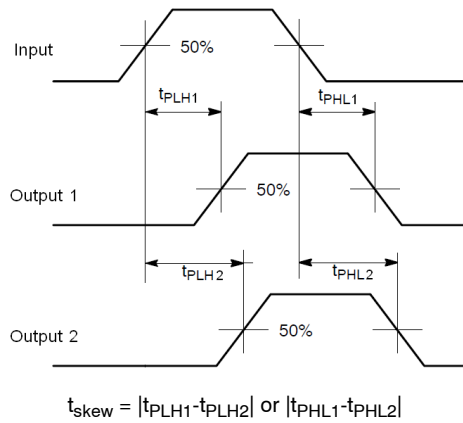
VNA Source  
Balanced Port 1



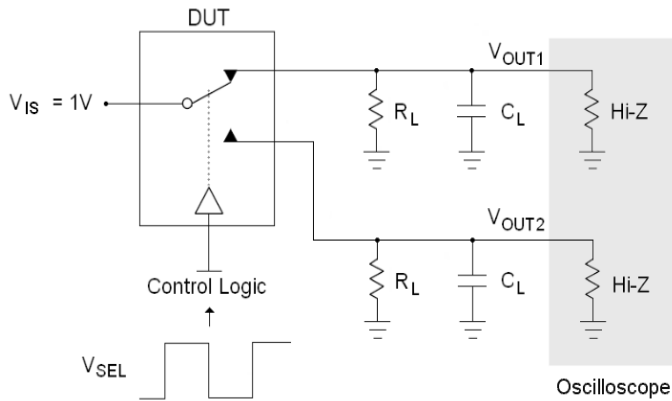
**Figure 4. Differential Off Isolation ( $S_{DD21}$ )**



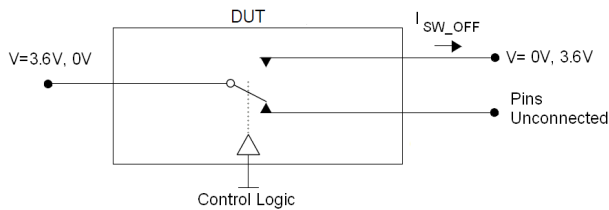
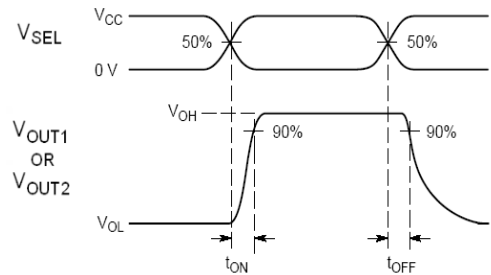
**Figure 5. Differential Crosstalk ( $S_{DD21}$ )**



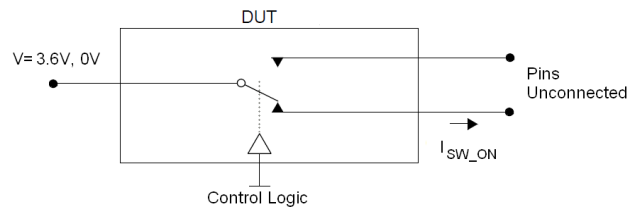
**Figure 6. Bit-to-Bit and Channel-to-Channel Skew**



**Figure 7.  $t_{ON}$  and  $t_{OFF}$**



**Figure 8. Off State Leakage**



**Figure 9. On State Leakage**

TYPICAL OPERATING CHARACTERISTICS

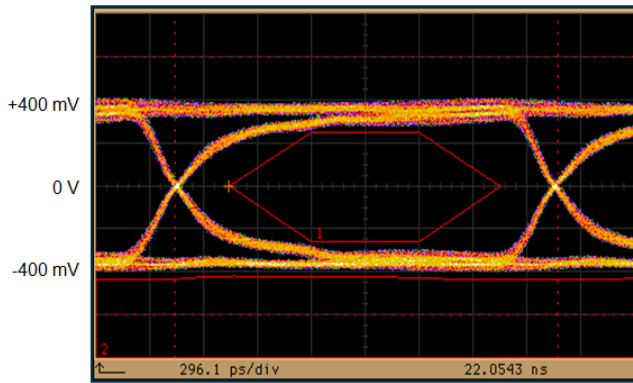


Figure 10. USB 2.0 High Speed Eye Diagram

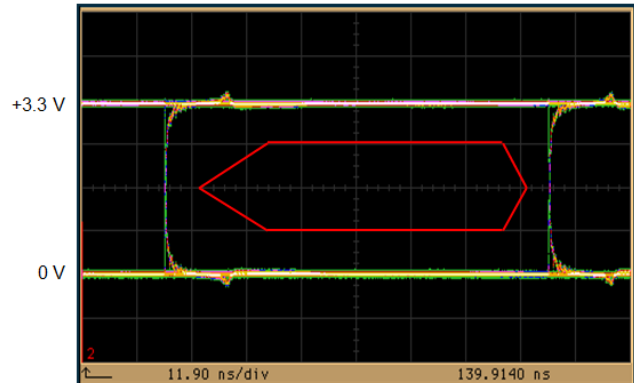


Figure 11. USB 1.1 Full Speed Eye Diagram

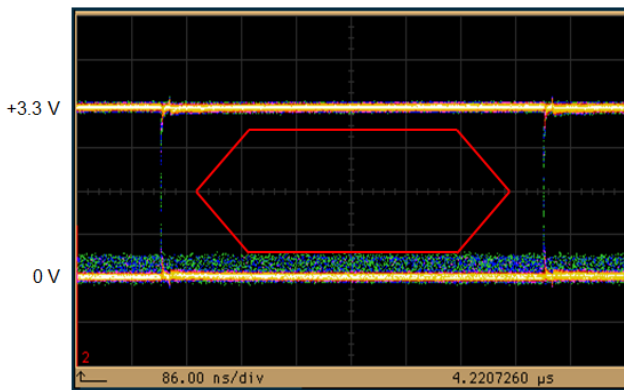


Figure 12. USB 1.0 Low Speed Eye Diagram

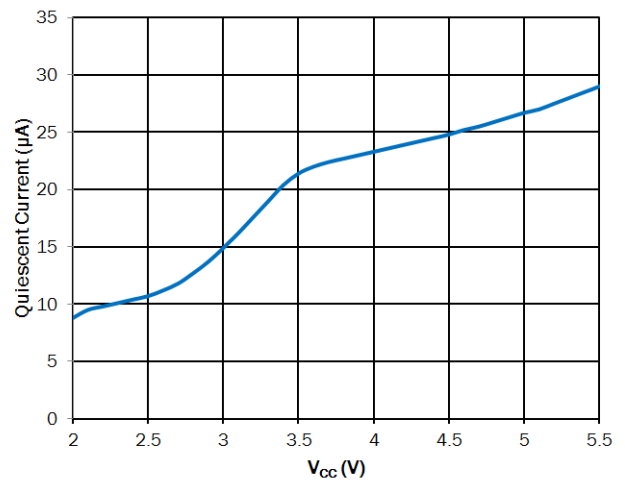


Figure 13. Product Supply Current

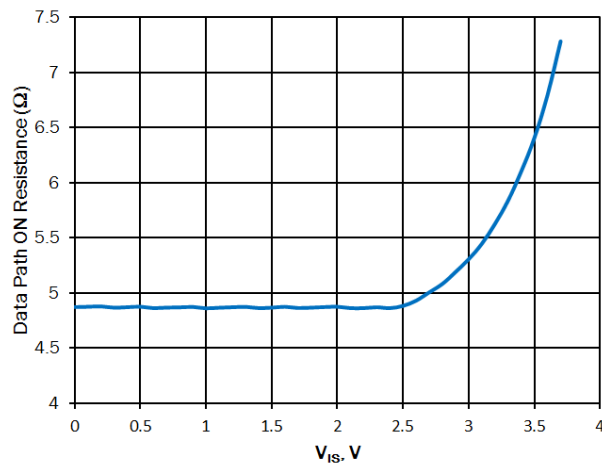


Figure 14. Data Path On Resistance

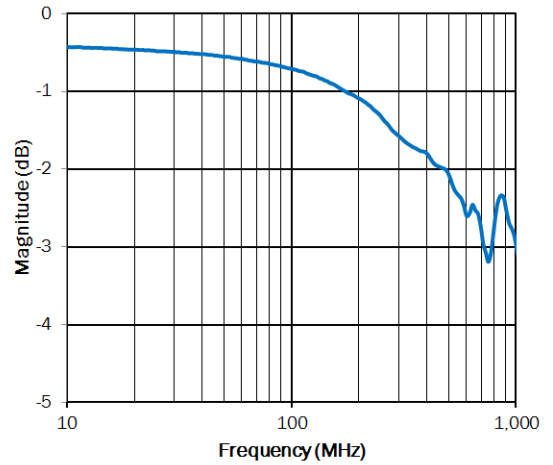
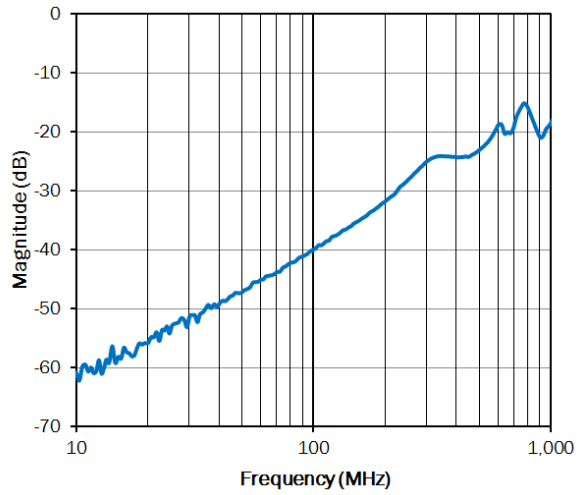
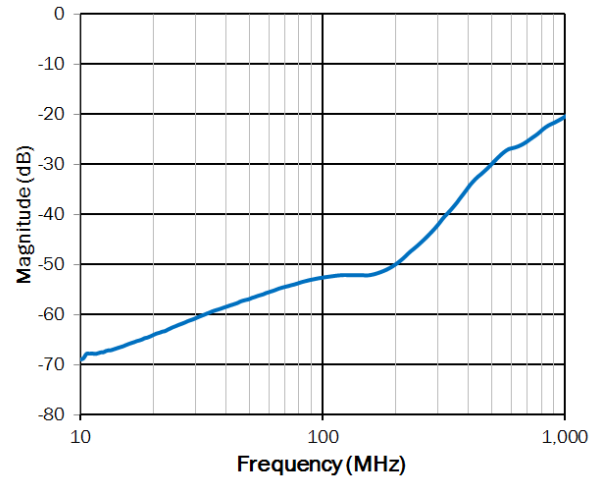


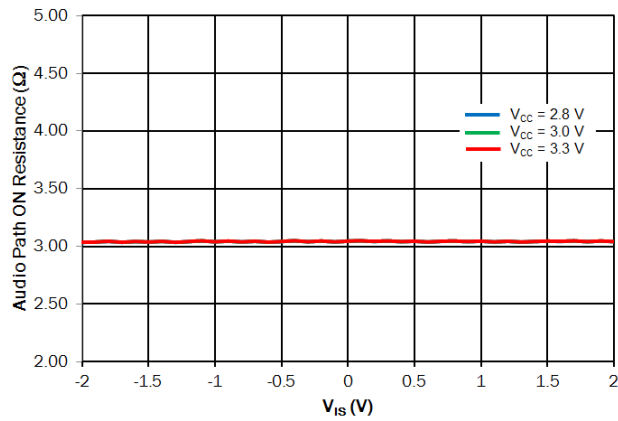
Figure 15. Data Switch Differential Insertion Loss



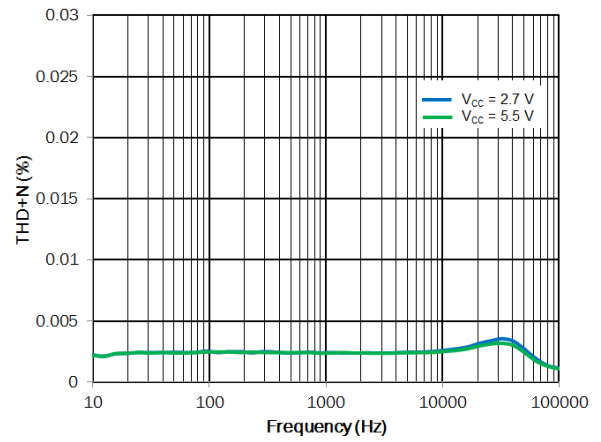
**Figure 16. Data Switch Differential Off-Isolation**



**Figure 17. Data Switch Differential Crosstalk**



**Figure 18. Audio Path On Resistance**



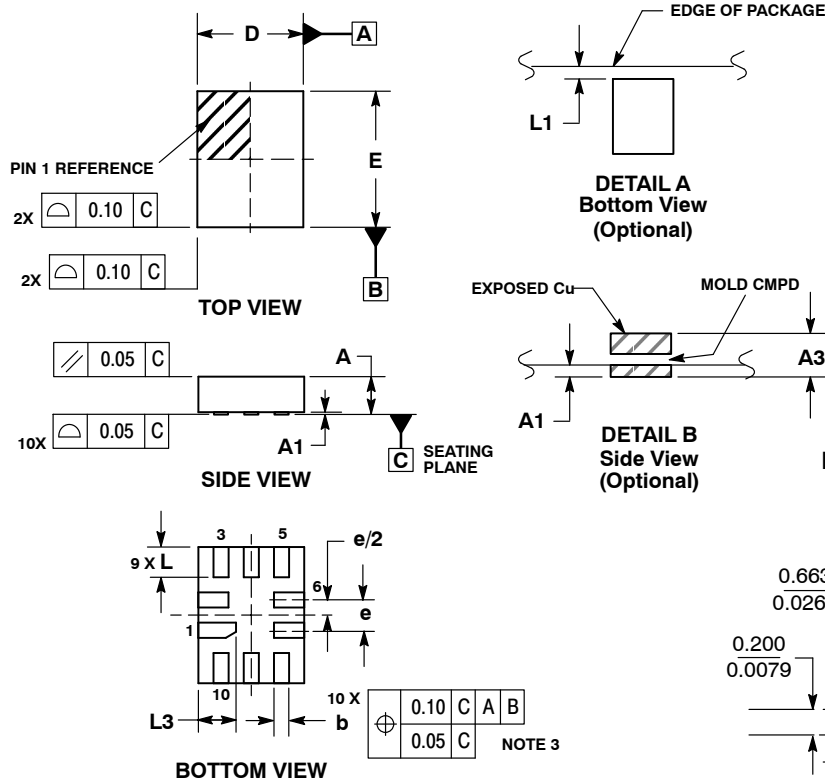
**Figure 19. Audio THD**



# NL3S22S

## PACKAGE DIMENSIONS

### UQFN10 1.4x1.8, 0.4P CASE 488AT ISSUE A

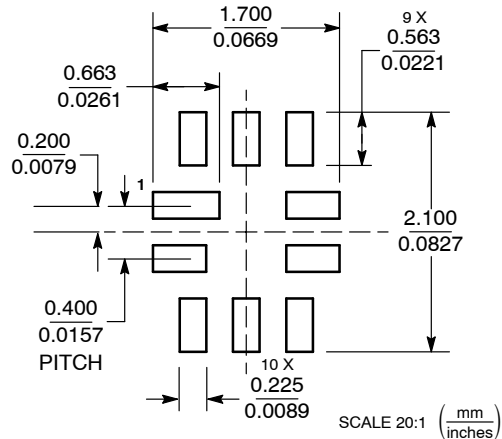


#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

MILLIMETERS		
DIM	MIN	MAX
A	0.45	0.60
A1	0.00	0.05
A3	0.127 REF	
b	0.15	0.25
D	1.40 BSC	
E	1.80 BSC	
e	0.40 BSC	
L	0.30	0.50
L1	0.00	0.15
L3	0.40	0.60

#### MOUNTING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERM/D.

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

## PUBLICATION ORDERING INFORMATION

### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor  
19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA  
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada  
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada  
Email: [orderlit@onsemi.com](mailto:orderlit@onsemi.com)

**N. American Technical Support:** 800-282-9855 Toll Free  
USA/Canada  
**Europe, Middle East and Africa Technical Support:**  
Phone: 421 33 790 2910  
**Japan Customer Focus Center**  
Phone: 81-3-5817-1050

**ON Semiconductor Website:** [www.onsemi.com](http://www.onsemi.com)

**Order Literature:** <http://www.onsemi.com/orderlit>

For additional information, please contact your local Sales Representative

# Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[ON Semiconductor:](#)

[NL3S22SMUTAG](#)